

**DECLARATION AND POWER OF ATTORNEY
NOT ACCOMPANYING APPLICATION FOR UNITED STATES PATENT**

As a below named inventor, I declare that my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor if only one name is listed below, or an original, first and joint inventor if plural inventors are named below, of the subject matter which is claimed and for which a patent is sought on the invention entitled as set forth below, which is described in the specification of **Application Serial No. 09/909,013** filed **July 19, 2001**; that I have reviewed and understand the contents of the specification, including the claims, as amended by any amendment specifically referred to in this declaration; that no application for patent or inventor's certificate on this invention has been filed by me or my legal representatives or assigns in any country foreign to the United States of America except **Application No. 2000-225,339** filed **July 26, 2000** in **Japan** and from which priority is claimed under 35 USC 119; and that I acknowledge my duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56;

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Title: SEMICONDUCTOR PACKAGE INSULATION FILM AND MANUFACTURING METHOD THEREOF

Inventor: Makoto YOSHINO and Kenji MASUMOTO

Power of Attorney: I hereby appoint the following attorneys to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

Frederick J. Telecky, Jr., Reg. No. 29,979
Jay M. Cantor, Reg. No. 19,906
William B. Kempler, Reg. No. 28,228
All attorneys and agents under customer number 23494

Send Correspondence to: Telephone: 972/917-5339

Texas Instruments Incorporated
Attn: William B. Kempler
P.O. Box 655474, M/S 3999
Dallas, TX 75265

(1) Name of Inventor: **Makoto YOSHINO**

Residence and
Post Office Address: 3, Haruki 5-kumi
Beppu-shi
Ohita 874-0913 Japan

Country of Citizenship: JAPAN

Signature of Inventor: Makoto Yoshino

Date: August 23, 2001

(2) Name of Inventor: **Kenji MASUMOTO**

Residence and
Post Office Address: 1969-26 Fujiwara, Hiji-machi, Hayami-gun
Oita 879-1502 Japan

Country of Citizenship: JAPAN

Signature of Inventor: Kenji Masumoto

Date: August 23, 2001